

# MA2C856 (MA856)

## Silicon epitaxial planar type

For band switching

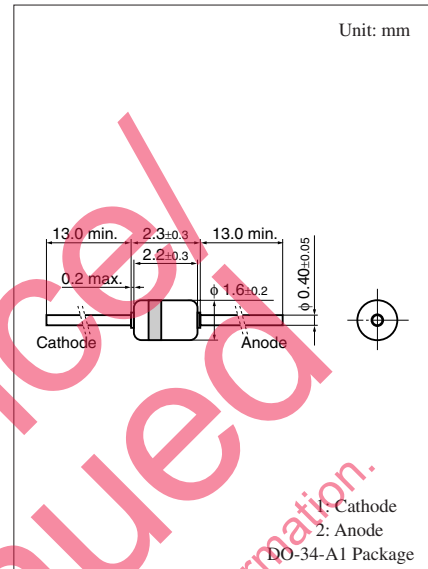
### ■ Features

- Extra-small DHD envelope, allowing to insert into a 5 mm pitch hole
- Less voltage dependence of the diode capacitance  $C_D$
- Low forward dynamic resistance  $r_f$
- Optimum for a band switching of tuner

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Reverse voltage	$V_R$	35	V
Forward current	$I_F$	100	mA
Operating ambient temperature *	$T_{opr}$	-25 to +85	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +100	$^\circ\text{C}$

Note) \*: Maximum ambient temperature during operation.



### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	$V_F$	$I_F = 100 \text{ mA}$			1	V
Reverse current *	$I_R$	$V_R = 33 \text{ V}$			100	nA
Diode capacitance	$C_D$	$V_R = 15 \text{ V}$ , $f = 1 \text{ MHz}$			2	pF
Forward dynamic resistance	$r_f$	$I_F = 3 \text{ mA}$ , $f = 100 \text{ MHz}$			0.85	$\Omega$

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

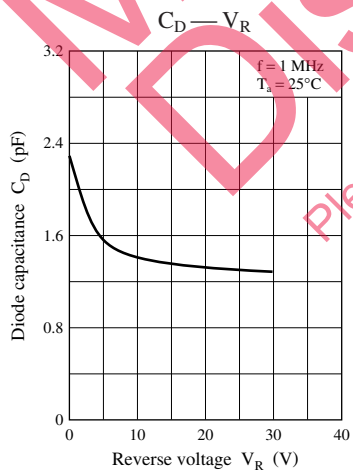
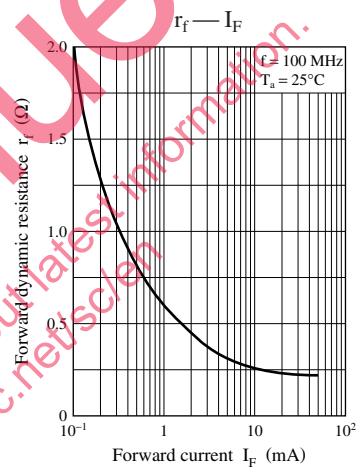
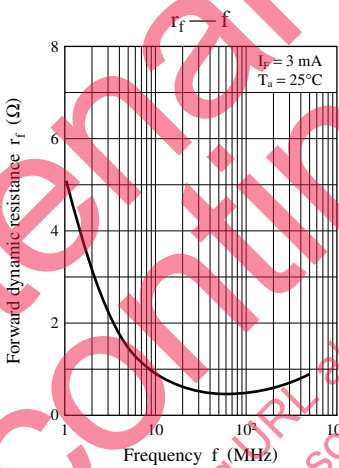
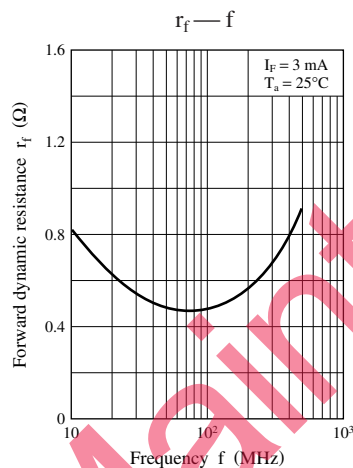
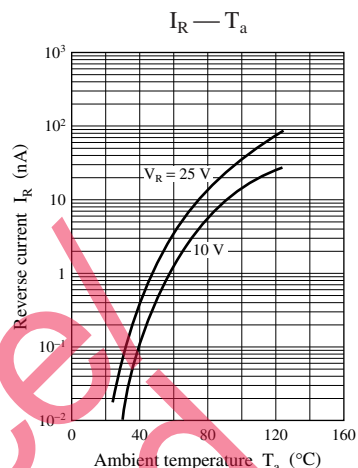
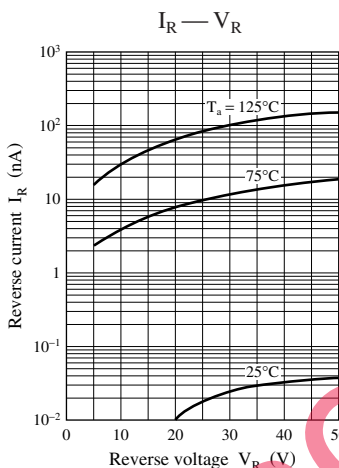
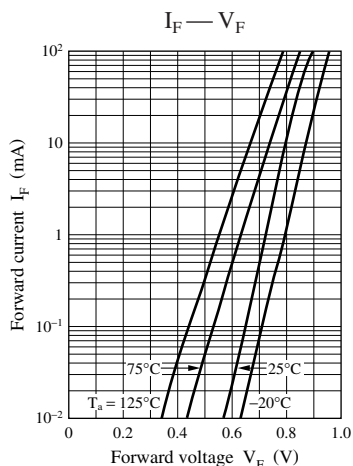
2. Absolute frequency of input and output is 100 MHz

3. \*:  $I_R$  should be measured under the condition of prevention the light.

### ■ Cathode Mark

Type No.	MA2C856
Color	Yellow

Note) The part number in the parenthesis shows conventional part number.



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